

3-Termal 500mA Negative Voltage Regulator

DESCRIPTION

The TS79M00 series of fixed output negative voltage regulators are intended as complements to the popular TS78M00 series device. These negative regulators are available in the same seven-voltage options as the TS7900 devices. In addition, one extra voltage option commonly employed in MECL systems is also available in the negative TS79M00 Series. Available in fixed output voltage options from -5.0 and -12 volts, these regulators employ current limiting, thermal shutdown, and safe-area compensation--making them remarkably rugged under most operating conditions. With adequate heat sinking they can deliver output currents in excess of 0.5 ampere.

FEATURES

- Output Voltage: -5 & -12V
- Output current up to 0.5A
- No external components required
- Internal thermal overload protection
- Internal short-circuit current limiting
- Output transistor safe-area compensation
- Output voltage offered in 4% tolerance
- Compliant to RoHS Directive 2011/65/EU and WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATION

- Switching power supply
- Home appliance





Pin Definition: 1. Ground 2. Input (tab) 3. Output

Notes: MSL 3 (Moisture Sensitivity Level) per J-STD-020

TYPICAL APPLICATION CIRCUIT



A common ground is required between the input and the output voltages. The input voltage must remain typically 2V above the output voltage even during the low point on the Input ripple voltage.

XX = these two digits of the type number indicate voltage.

* = C_{IN i}s required if regulator is located an appreciable distance from power supply filter.

** = C_{OUT} is not needed for stability; however, it does improve transient response.



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ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	LIMIT	UNIT				
Input Voltage	V _{IN}	-35	V				
Power Dissipation	P _D	Internal Limited	W				
Operating Junction Temperature	TJ	0~+125	°C				
Storage Temperature Range	T _{STG}	-65~+150	°C				

THERMAL PERFORMANCE							
PARAMETER	SYMBOL	LIN	UNIT				
	SYMBOL	TO-220	TO-252				
Junction to Case Thermal Resistance	$R_{\Theta JC}$	5	6	°C/W			
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	65	92	°C/W			

Notes: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. $R_{\Theta JA}$ shown below for single device operation on FR-4 PCB in still air.

ELECTRICAL SPECIFICATIONS TS79M05 (V_{IN} =-10V, I_{OUT} =350mA, 0°C≤T _J ≤125°C, C_{IN} =0.33µF, C_{OUT} =0.1µF, unless otherwise noted)							
PARAMETER	C	ONDITIONS	SYMBOL	MIN	ТҮР	MAX	UNIT
	T _J =25°C			-4.80	-5	-5.20	
Output voltage	-7.5V≤V _{IN} 5mA≤I _{OUT}	≤-20V, ≤500mA, P _D ≤5W	V _{OUT}	-4.75	-5	-5.25	V
Line Degulation	T -05°0	-7.5V≤V _{IN} ≤-25V	DEO		7	50	mV
Line Regulation	TJ=25°C	-8V≤V _{IN} ≤-18V			2	30	
	T _J =25°C	5mA≤I _{OUT} ≤500mA	DEO		20	100	
Load Regulation		5mA≤I _{OUT} ≤200mA	- REG _{LOAD}		10	50	
Quiescent Current	I _{OUT} =0, T _J	=25°C	Ι _Q		4	8	
Quiescent Current Change	-7.5V≤V _{IN} ≤-25V		Δl _Q			1	mA
	5mA≤I _{OUT} ≤500mA					0.5	
Output Noise Voltage	10Hz≤f≤1	00kHz, TJ=25°C	V _N		40		μV
Ripple Rejection Ratio	f=120Hz,	-8V≤V _{IN} ≤-18V	RR	54	66		dB
Voltage Drop	I _{OUT} =500n	nA, T _J =25°C	V _{DROP}		2		V
Peak Output Current	T _J =25°C		lo peak		2.1		А
Temperature Coefficient of Output Voltage	I _{OUT} =5mA	., 0°C≤TJ≤125°C	$\Delta V_{OUT} / \Delta T_{J}$		-0.1		mV/ºC



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ELECTRICAL SPEC (V _{IN} =-19V, I _{OUT} =350mA, 0°C			IuF, unless oth	erwise no	ted)		
PARAMETER		ONDITIONS	SYMBOL	MIN	ТҮР	MAX	UNIT
Output voltage	T _J =25°C			-11.53	-12	-12.48	
	-14.5V≤V 5mA≤I _{OUT}	_N ≤-27V, ≤500mA, P _D ≤5W	V _{OUT}	-11.42	-12	-12.60	V
Line Regulation	T -05°0	-14.5V≤V _{IN} ≤-30V	DEO		10	240	mV
	TJ=25°C	-15V≤V _{IN} ≤-19V	- REG _{LINE}		3	120	
Load Regulation	TJ=25°C	5mA≤I _{OUT} ≤500mA	550		12	240	
		5mA≤I _{OUT} ≤200mA	REG _{LOAD}		4	120	
Quiescent Current	I _{OUT} =0, T _J	=25°C	Ι _Q		4.3	8	
Quiescent Current Change	-14.5V≤V _{IN} ≤-30V		Δl _Q			1	mA
	5mA≤I _{OUT} ≤500mA					0.5	
Output Noise Voltage	10Hz≤f≤1	00kHz, TJ=25°C	V _N		75		μV
Ripple Rejection Ratio	f=120Hz,	-15V≤V _{IN} ≤-25V	RR	55	70		dB
Voltage Drop	I _{ουτ} =500mA, Τ _J =25°C		V _{DROP}		2		V
Peak Output Current	T _J =25°C		lo peak		2.1		А
Temperature Coefficient of Output Voltage	I _{OUT} =5mA, 0°C≤T _J ≤125°C		$\Delta V_{OUT} / \Delta T_{J}$		-1		mV/ºC

Note:

1. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible, and thermal effects must be taken into account separately

2. This specification applies only for DC power dissipation permitted by absolute maximum ratings.

ORDERING INFORMATION

OUTPYT VOLTAGE	PART NO.	PACKAGE	PACKING	
5V	TS79M05CZ C0G	TO-220	50pcs / Tube	
	TS79M05CP ROG	TO-252	2,500pcs / 13" Reel	
12V	TS79M12CP ROG	TO-252	2,500pcs / 13" Reel	



CHARACTERISTICS CURVES





Figure 1. Worse Case Power Dissipation vs. Ambient Figure 2. Peak Output Current as a Function of Input-**Temperature (TO-220)**



Figure 5. Ripple Rejection vs. Frequency

Output Differential Voltage



Figure 4. Bias Current vs. Output Current



Figure 6. Ripple Rejection vs. Output Voltage



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APPLICATION INFORMATION



Figure 7. DPAK Thermal Resistance and Maximum Power Dissipation vs. P.C.B Copper Length



PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

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9h





MARKING DIAGRAM



хх	= Output Vo	ltage					
	05 =-5V						
Υ	= Year Code						
М	= Month Code for Halogen Free Product						
	O =Jan	Ρ	=Feb	Q	=Mar	R	=Apr
	S =May	Т	=Jun	U	=Jul	۷	=Aug
	W =Sep	Х	=Oct	Υ	=Nov	Ζ	=Dec
L	= Lot Code						
CZ	= Package	code					

TO-220

PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

TAIWAN

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SUGGESTED PAD LAYOUT (Unit: Millimeters)



TO-252 (DPAK)

MARKING DIAGRAM



- **XX** = Output Voltage
 - **05** =-5V **12** =-12V
- Y = Year Code
 - **M** = Month Code for Halogen Free Product
 - O =Jan P =Feb Q =Mar R =Apr S =May T =Jun U =Jul V =Aug
 - W = Sep X = Oct Y = Nov Z = Dec
 - L = Lot Code
- **CP** = Package code



TS79M00 Series

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